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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Bradley Dale Mitchell

SERIAL NO.: 09/943,569

FILING DATE: August 30, 2001

TITLE: System and Method for Removing Deposited Material from Within a Semiconductor Fabrication Device

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ART UNIT: 1746

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TRANSMITTAL FOR FORMAL DRAWINGS

With respect to the above-identified patent application, enclosed herewith for filing are nine (9) sheets of Formal Drawings.

Respectfully submitted
THELEN REID & PRIEST LLP

Dated: August 27, 2004

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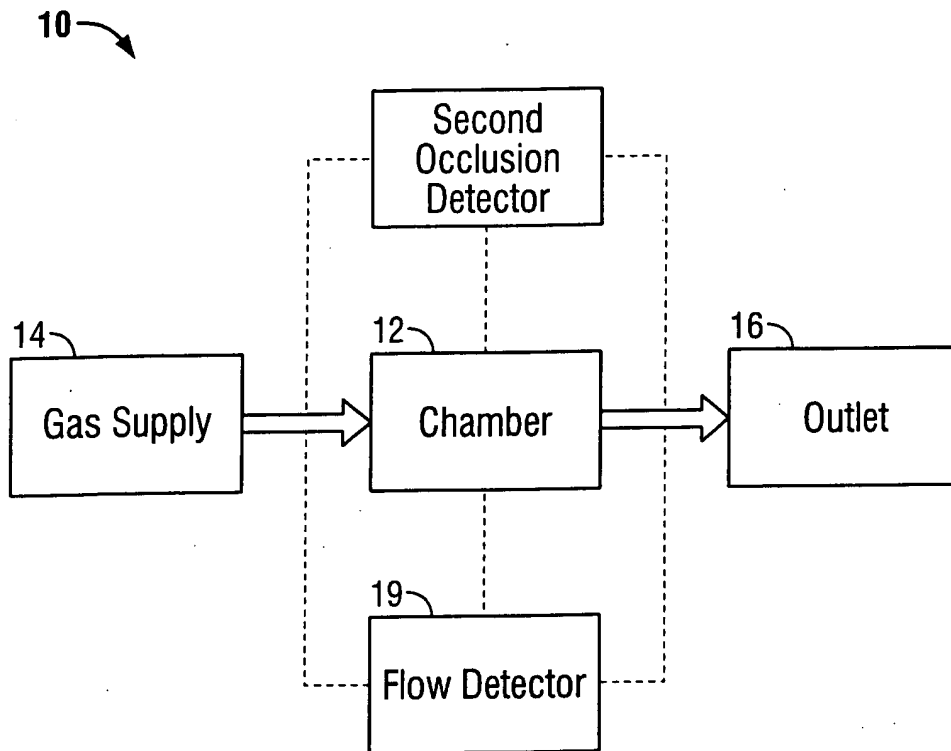


FIG. 1



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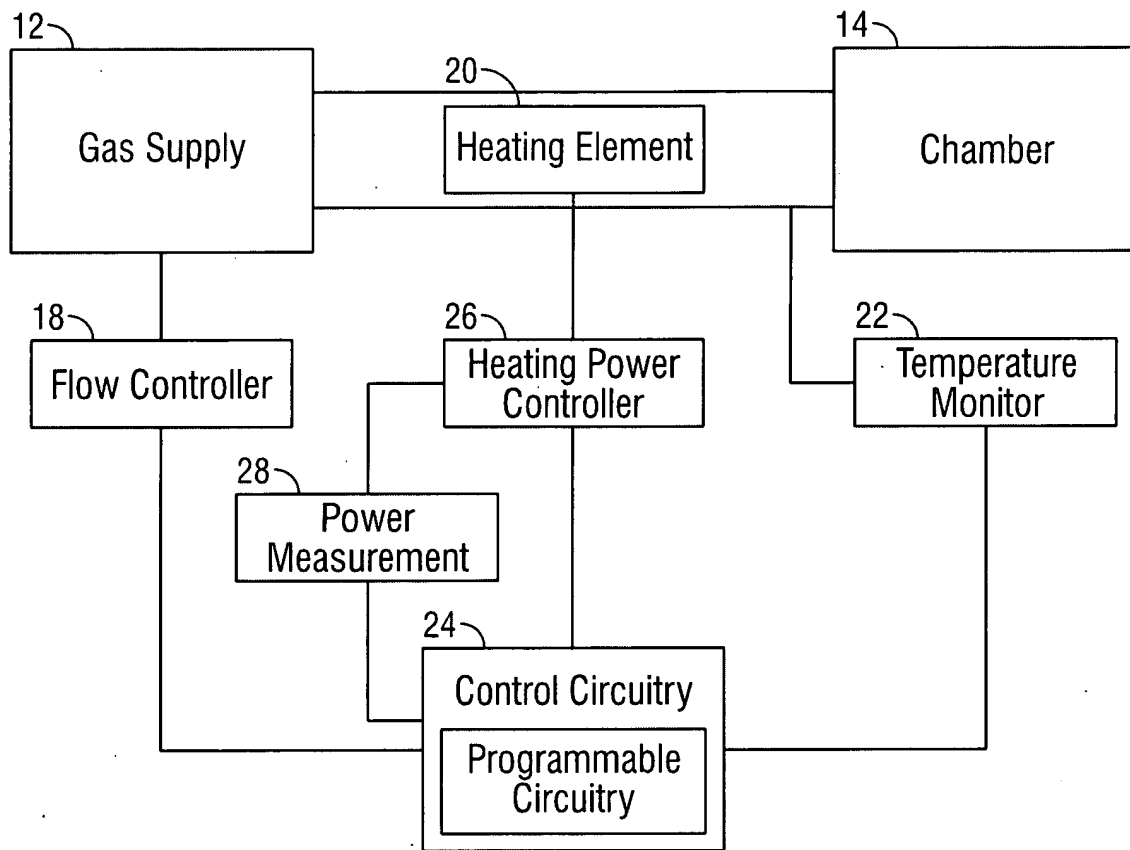


FIG. 2



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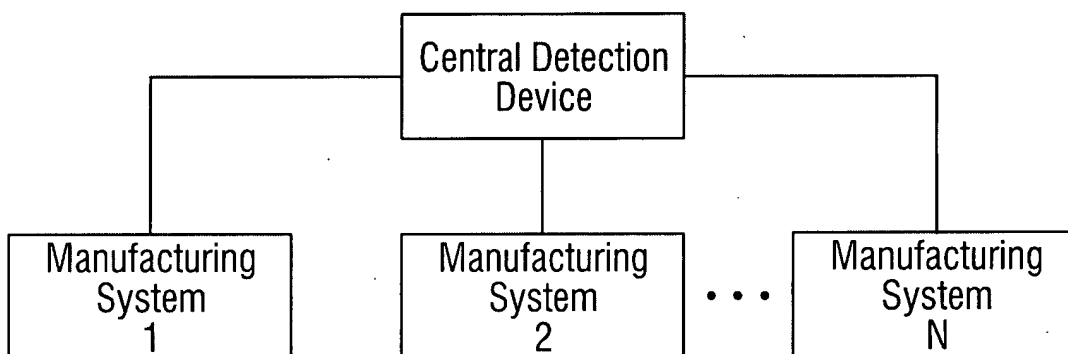


FIG. 3



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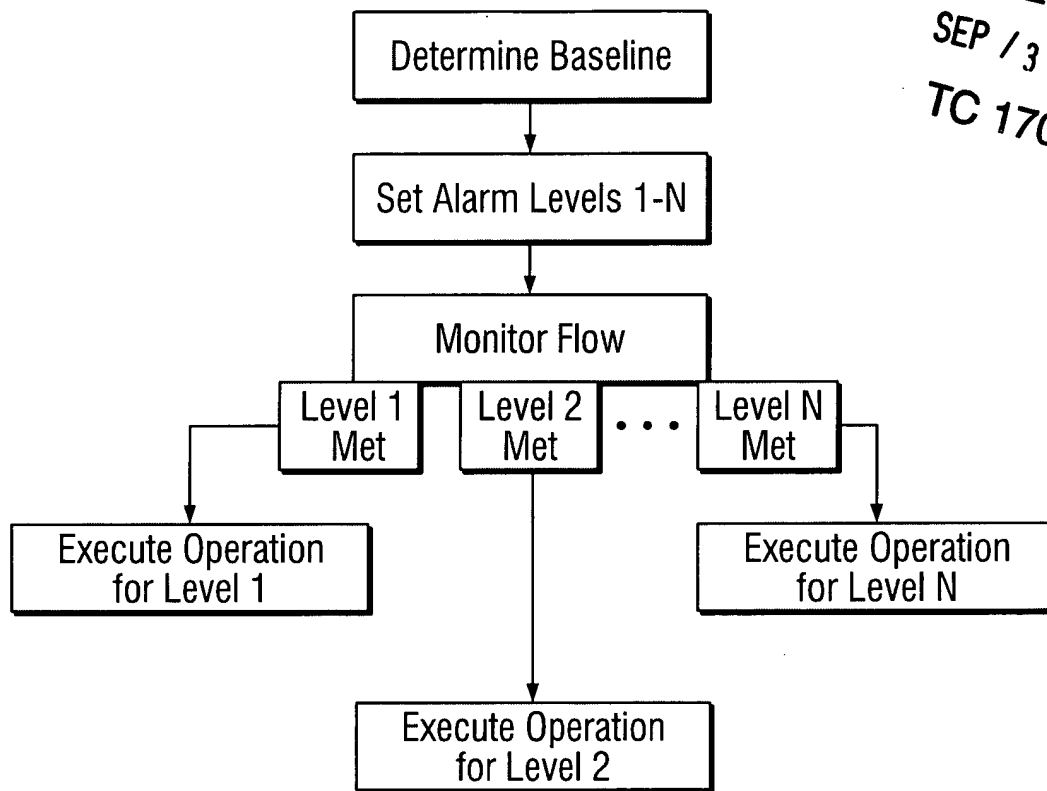


FIG. 4



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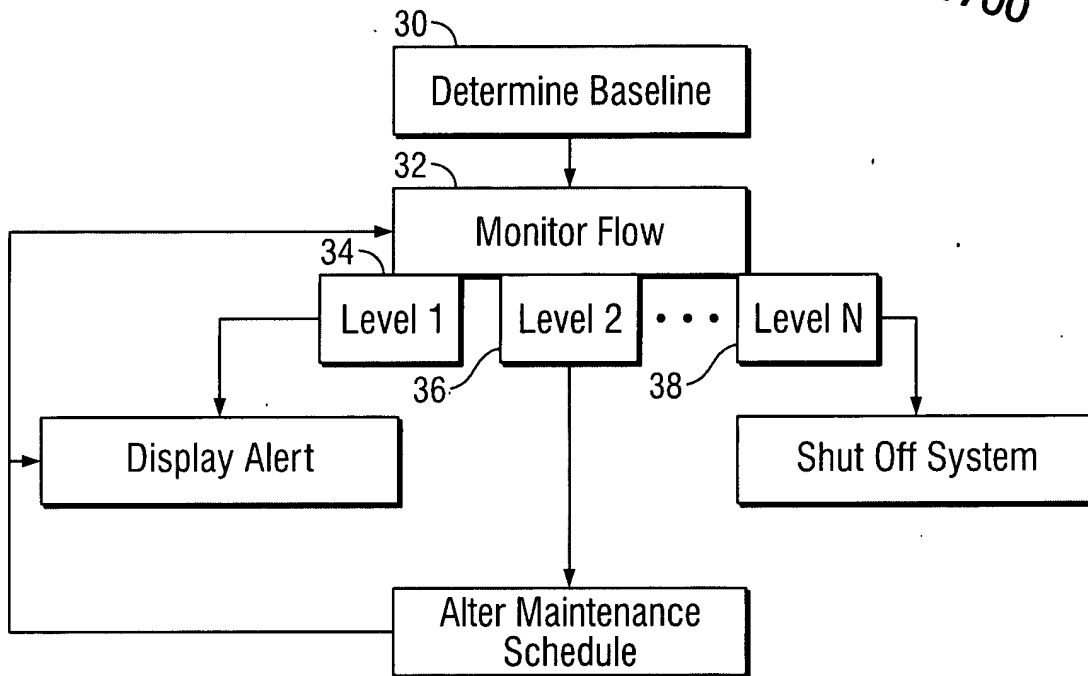


FIG. 5



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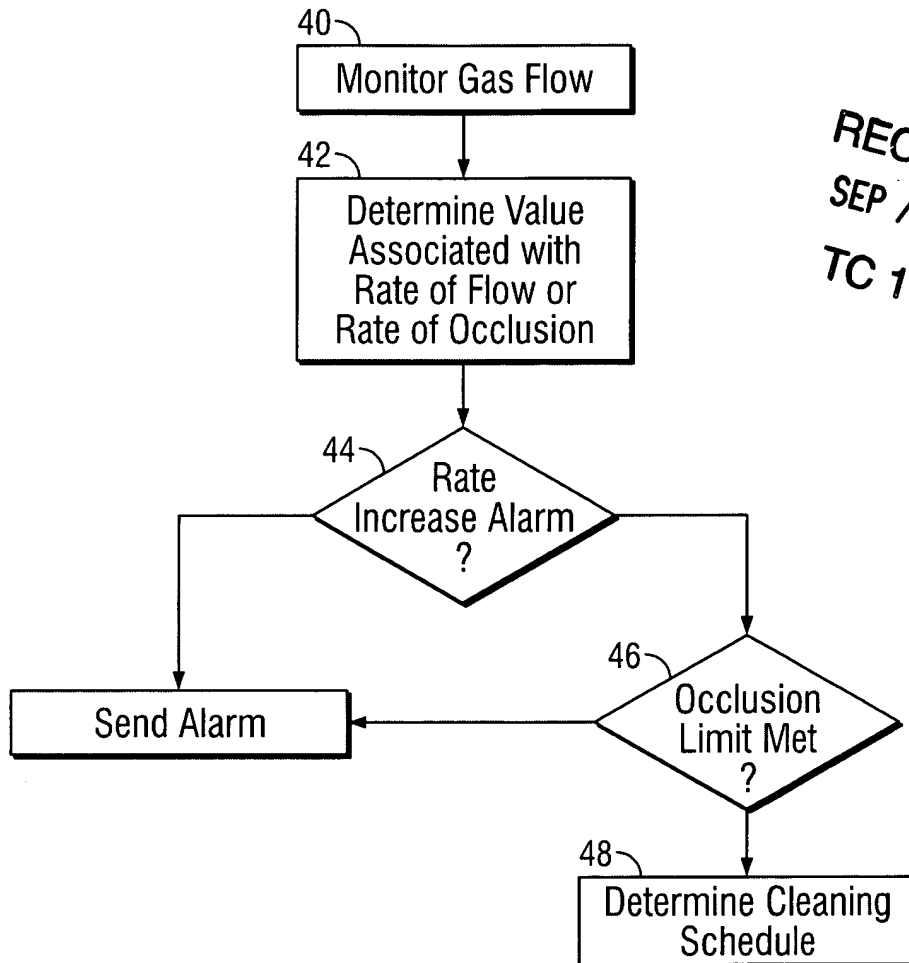


FIG. 6



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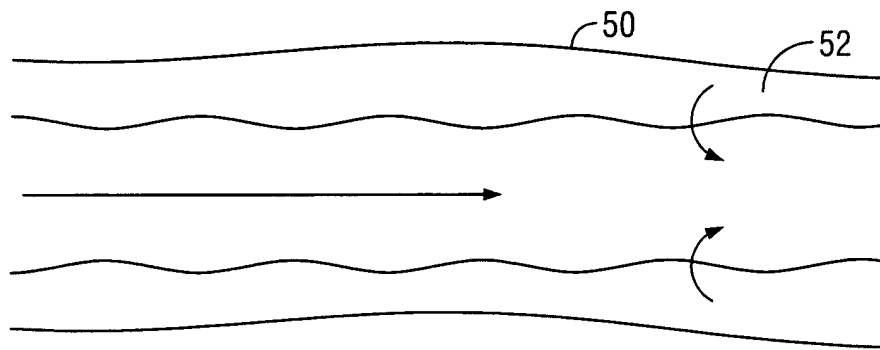


FIG. 7



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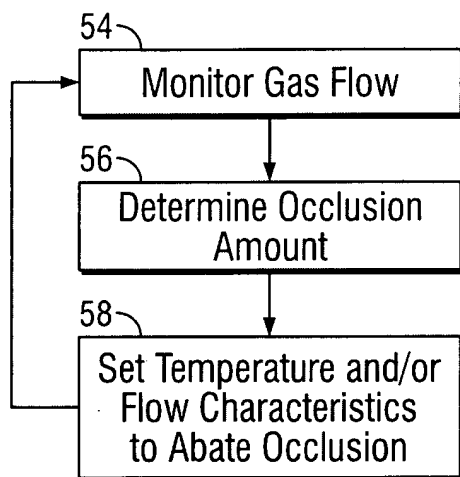


FIG. 8



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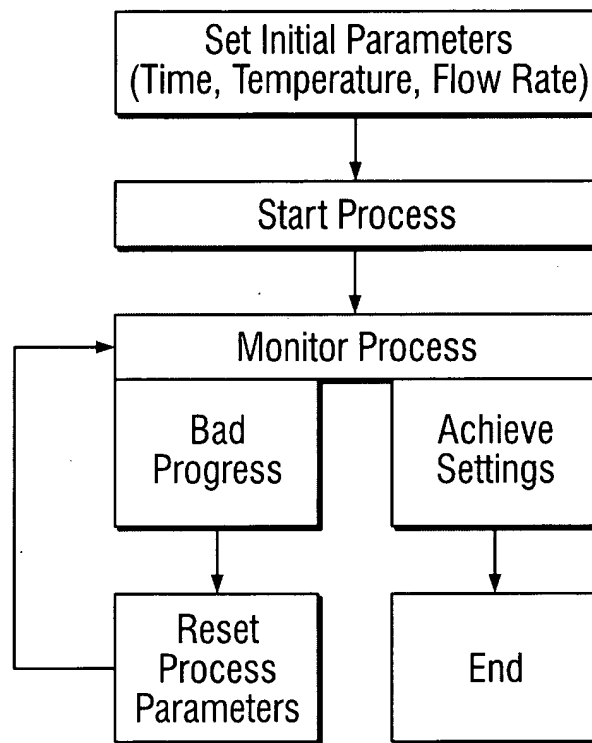


FIG. 9